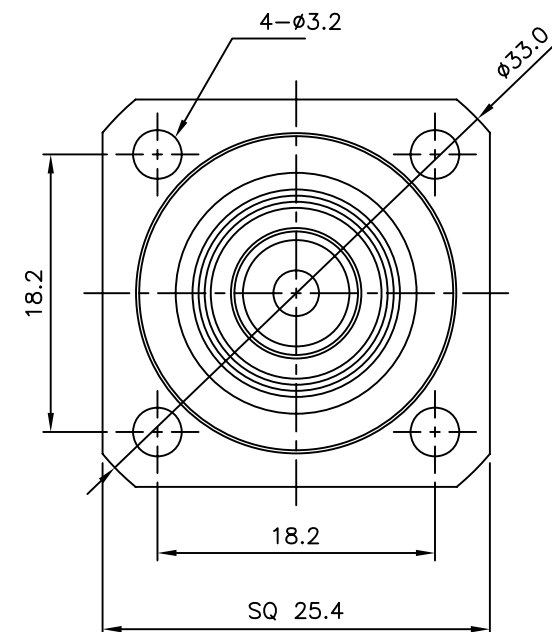
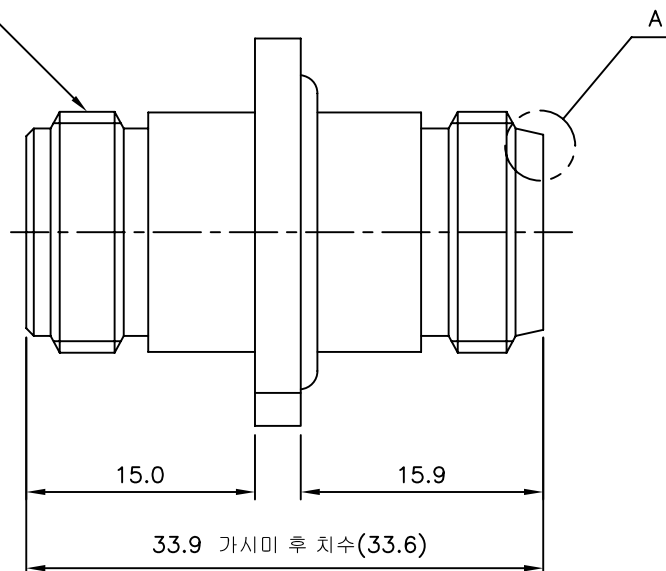


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.M.LEE	I.C.KIM	2014.12.22.
1	[설번No. 201501-0006] 조립 불량 소지로 인한 핀에 홈 추가	H.J.LEE	I.C.KIM	2015.01.09.

2-5/8-24UNEF-2A



* 주기

1. A부분 가시미 작업할것.

*조립시 핀 식별 확인 후

식별부 위치는 BODY 가시미 하는 곳으로 조립 할 것

5	GASKET	1	SILICONE		DGK00046-N/1
4	INSULATOR	2	TEFLON		DIN00699-N/1
3	CONTACT	1	BeCu	Gold Plate	DCT03329-5/1
2	BODY	1	MBsBD	Nickel Plate	DBD03818-5/1
1	BODY	1	MBsBD	Nickel Plate	DBD03819-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2015. 01. 09		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL	-	CHECKED BY		KJ COMTECH CO.,LTD. TITLE N50 (J) N50 (J) 4 HOLE
		DRAWN BY	H.J.LEE	
FINISH	-	SCALE	2/1	 A4 DWG NO. AD00544-7/1 REVISION 1 SHEET 1 of 1
		UNIT	mm	